

#### zQSFP+/QSFP28

TE Internal #: 2289129-2

QSFP, QSFP+ & zQSPF+, Cage Assembly with Integrated

Connector, 2 x 2, Internal/External EMI Springs, Included Lightpipe,

Standard, zQSFP+/QSFP28

View on TE.com >



Connectors > Pluggable IO Connectors & Cages > QSFP, QSFP+ & zQSPF+











Pluggable I/O Product Type: Cage Assembly with Integrated Connector

Port Matrix Configuration: 2x2

EMI Containment Feature Type: Internal/External EMI Springs

Included Lightpipe: Yes
Enhancements: Standard

### **Features**

### **Product Type Features**

Form Factor	zQSFP+
Cage Type	Stacked
Pluggable I/O Product Type	Cage Assembly with Integrated Connector
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

### **Configuration Features**

Port Matrix Configuration	2 x 2
Number of Ports	4
Lightpipe Configuration	All Four Left Indicator Up
Number of Rear EONs per Port Column	3
Number of Positions	152

### **Electrical Characteristics**

Data Rate (Max)	25 Gb/s	
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#### **Contact Features**

Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
Contact Underplating Material	Tin
PCB Contact Termination Area Plating Material	Gold
Contact Current Rating (Max)	.5 A

#### **Termination Features**

Termination Post & Tail Length	2 mm[.079 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit

### Mechanical Attachment

Connector Mounting Type	Board Mount	
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### **Housing Features**

Cage Material	Nickel Silver
Centerline (Pitch)	.8 mm[.032 in]

### **Dimensions**

PCB Thickness (Recommended)	1.57 mm[.062 in]

# Usage Conditions

Operating Temperature Range	-40 - 85 °C[-40 - 185 °F]

# Operation/Application

Heat Sink Compatible	No
For Use With Pluggable I/O Products	QSFP28 Cable Assembly, QSFP28 MSA Compatible Transceiver
Pluggable I/O Applications	SFP+ Stacked Belly-to-Belly
Circuit Application	Signal

# **Industry Standards**

UL Flammability Rating	UL 94V-0
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# Packaging Features

## Other

EMI Containment Feature Type	Internal/External EMI Springs
Included Lightpipe	Yes



Enhancements Standard	
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# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts





Also in the Series | zQSFP+/QSFP28





Heat Sinks(1)



Pluggable I/O Cable Assemblies(81)

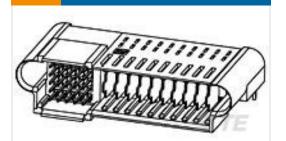


QSFP, QSFP+ & zQSPF+(425)

# Customers Also Bought



TE Part #2-2129710-6
RIGHT SIDE LGA3647-0 SOCKET-P0
FOR ODM



TE Part #2-1926730-5
AssyMINIPAKHDL25a10pRAplugBdlk



TE Part #2-1926739-5
AssyMinipak Hdl25s10pRARecptSc





TE Part #2007262-2 SFP+ 1x2 Cage Assembly, Light

TE Part #2187794-1 SW PIR RECT, 85OHM, 8X10 TE Part #2-2214617-5 SFP+assy 2x1 EMI Spring, 4LP Sn



L265MM

zQSFP+ connector assembly

TE Part #2016623-6
RF CA,1.0-2.3 BULKHEAD TO UMCC
GEN1,1.37

# **Documents**

## **Product Drawings**

ZQSFP+ CAGE& CONN 2X2, EMI SPRING, 4 LP

English

# **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2289129-2\_A.2d\_dxf.zip



English

**Customer View Model** 

ENG\_CVM\_CVM\_2289129-2\_A.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2289129-2\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

QSFP28/56 and zQSFP+ Interconnects

English

**Product Specifications** 

**Application Specification** 

English